

A new range of CCM03 connectors have been developed to interface with SIM/SAM cards as defined by GSM11-11 and ENV1375-1. The connectors are available with either hinged covers or fixed covers and have been designed to minimize the amount of space needed for PCB mounting.

Features

Hinged Cover

- Available with 6 or 8 contacts, with or without PCB locating pegs.
- Available with insulated card presence switch.
- The cover springs open when unlocked while the card is in place.
- The molding is polarized so that the cover can only be closed if the card is correctly inserted.
- The cover can be replaced without removing the connector from the PCB.
- Inspection slots allow an electrical test to be made without opening the cover.
- The overall height of the connector is only 2,5 mm. The amount of space needed to mount the connector is just 29,65 mm x 17,2 mm.

Fixed Cover

- Available with 6 or 8 contacts.
- The overall height of the connector is 2,85 mm max. Only 25,5 mm x 17,2 mm of board space is required to mount the connector.

General

- With tape and reel packaging as standard, the connectors are designed to be automatically pick-and-placed.
- The high temperature thermoplastic moldings are suited for infrared and convection soldering processes.
- By using an inlay finish in the contact area the life of the precious metal is extended by over 10 times that of standard gold plating.
- Robustly formed printed circuit tails allow a co-planarity of $\pm 0,05$ mm to be maintained.



Construction

Contacts	Copper alloy
Plating	Contact area : Gold alloy inlay or gold over nickel Terminals : Tin lead (2 μ min)
Moldings	High temp. thermoplastic UL 94V-0 rated
Slide lock/metal cover	Stainless steel

Mechanical Data

Number of Contacts	6 or 8
Mechanical life, hinged cover	10,000 cycles min
Mechanical life, fixed cover	50,000 cycles
Card insertion force	Hinged cover: 1 N max Fixed cover: 3 N max
Card extraction force	Hinged cover: 1 N max Fixed cover: 0.80 N min / 3 N max
Contact force	0.25 N min / 0.50 N max
Slide locking force	2 N min / 6 N max
Vibration	Frequency 10 to 500 Hz. Acceleration 50m/s ² Duration 6 hours - amplitude 0,35 mm Max electrical discontinuity 1 μ s
Shock	Peak value 500 m/s ² – Duration 11 ms 3 shocks in each direction of each axis Max electrical discontinuity 1 μ s

Contact Electrical Data

Insulation resistance	1,000 M Ω min
Resistance	100 m Ω max
Current rating	10 μ A min / 1 A max
Dielectric strength	750 Vrms min

Switch Electrical Data

Card detection switch	Normally open
Contact resistance	100 m Ω max
Dielectric strength	250 Vrms min
Current rating	1 mA min / 10m A max
Maximum power	0.2 VA

Environmental Data

Operating temperature	-40°C to +85°C
Soldering temperature	Temperature/time profile acc. to CECC00802 para. 6.1, Fig. 3 with peak temperature 250°C
Damp heat	IEC 512 test number 11c (10 days)
Salt mist	IEC 512 test number 11f (96 hours)

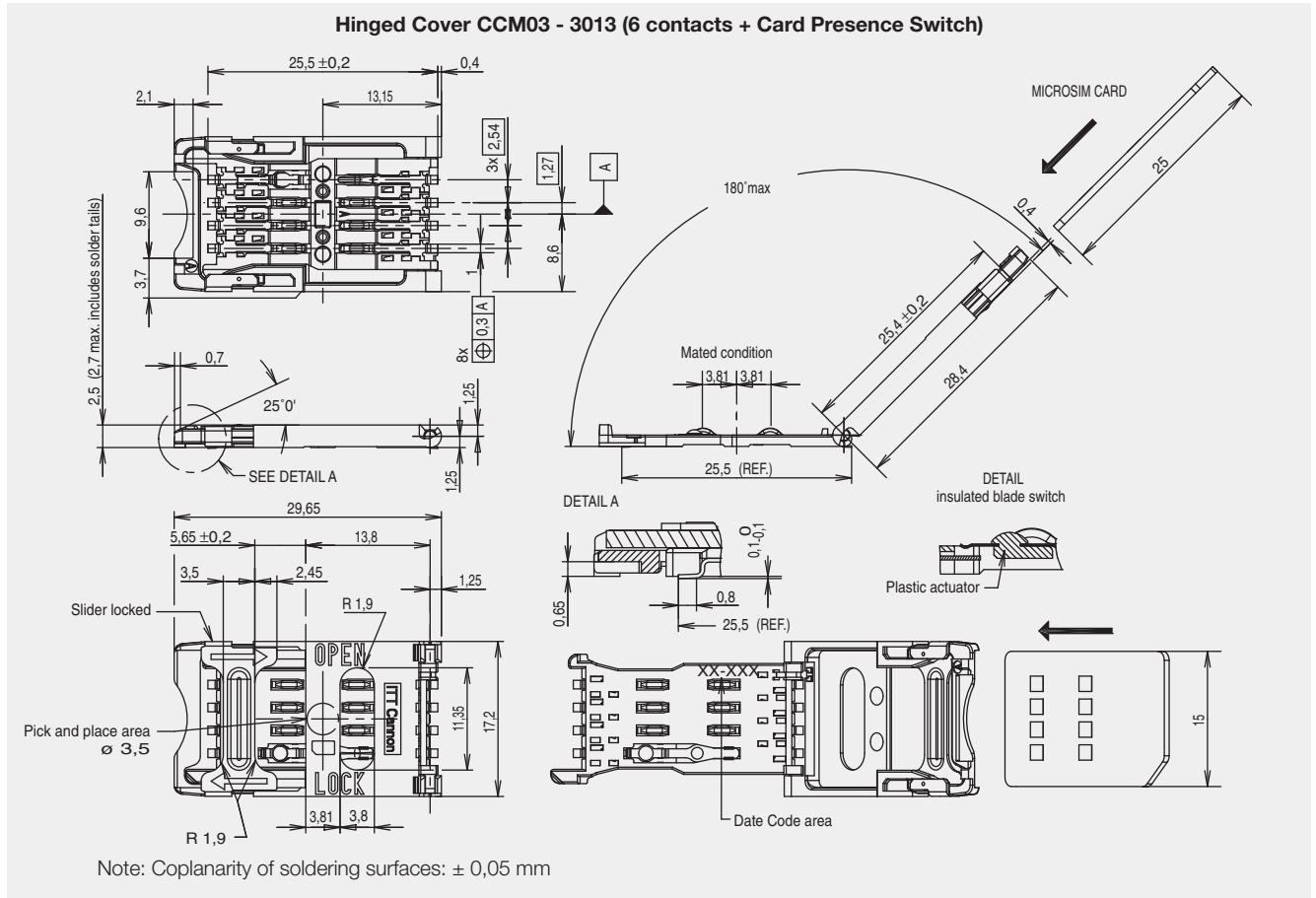
Packaging

Quantity per reel, see table next page.

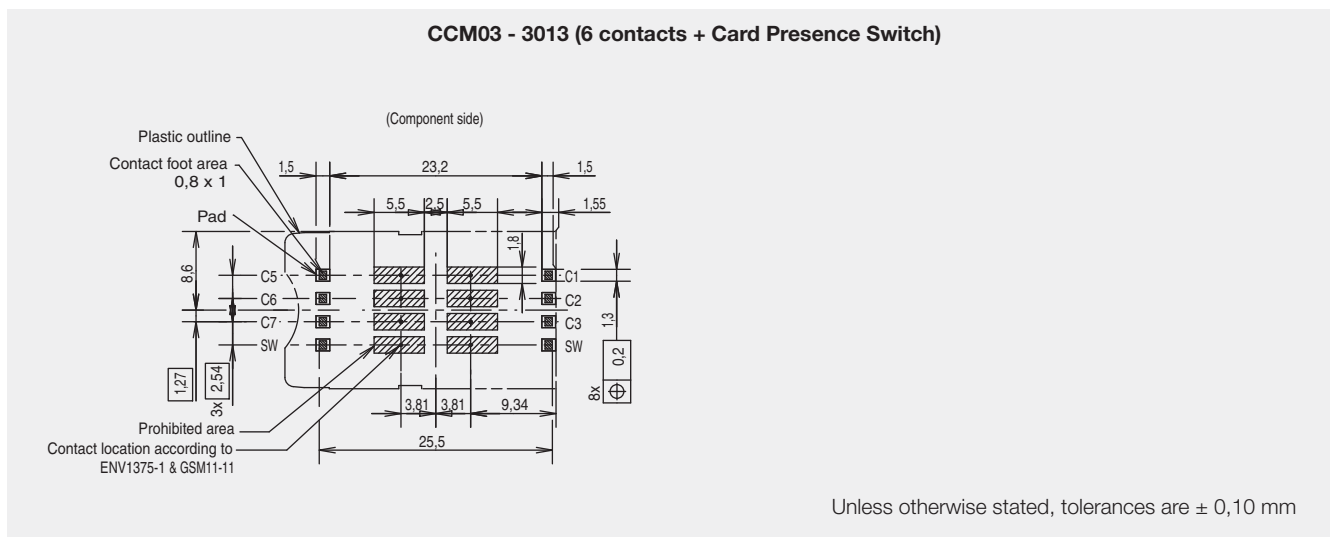
CCM03 MK II Hinged Cover

Insulated Card Presence Switch

Dimensional Drawings

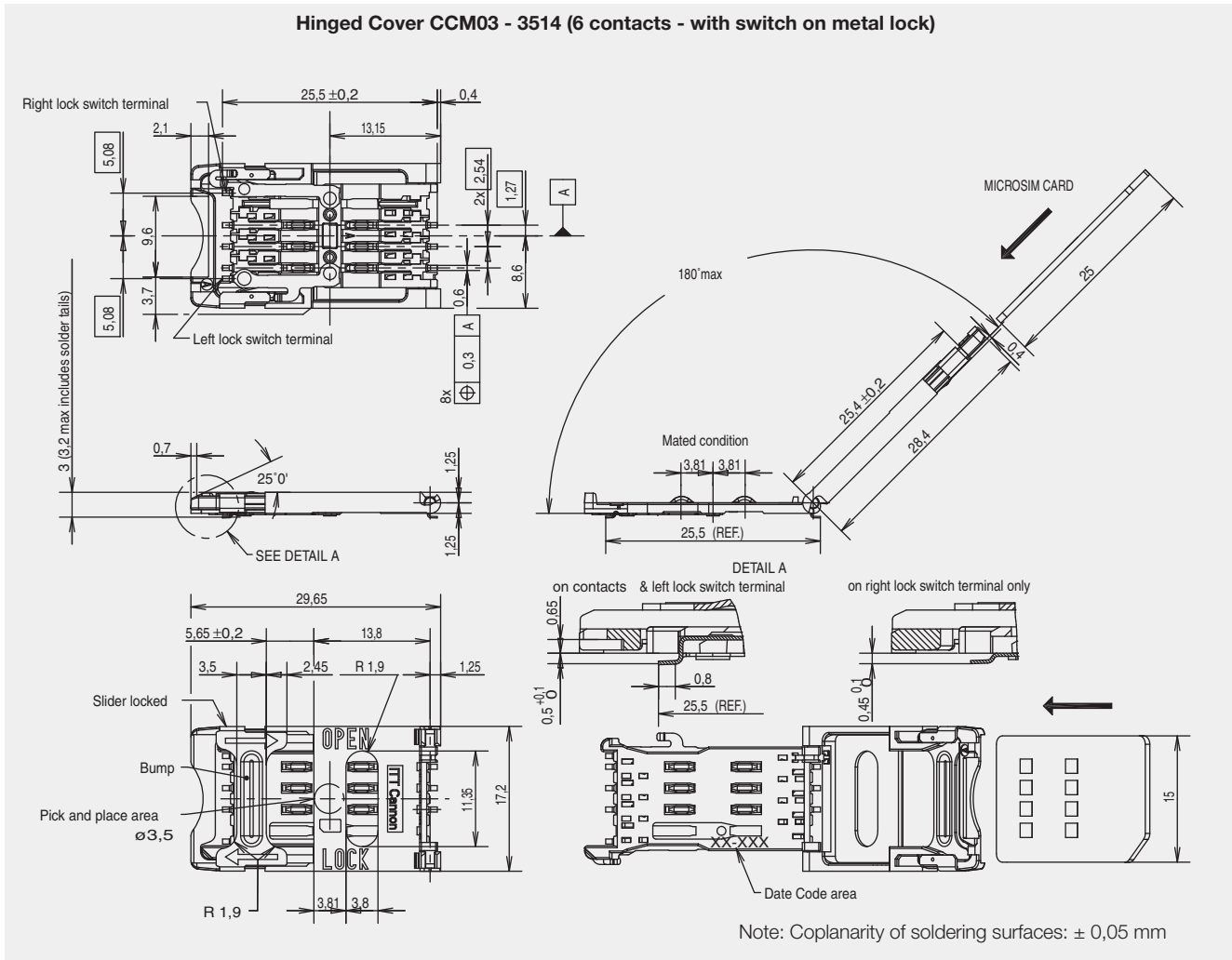


PCB Layout



CCM03 MK II Hinged Cover

Dimensional Drawings



PCB Layout

